# Silicon N-Channel/P-Channel Complementary Power MOS FET Array

## **HITACHI**

ADE-208-1212 (Z) 1st. Edition Mar. 2001

#### **Application**

High speed power switching

#### **Features**

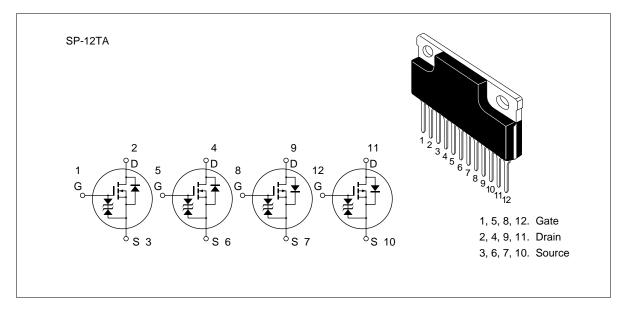
• Low on-resistance

$$\begin{split} &\text{N-channel:} \;\; R_{\text{DS(on)}} \leq 0.17 \;\; \text{, V}_{\text{GS}} \;\; = 10 \; \text{V, I}_{\text{D}} = 4 \; \text{A} \\ &\text{P-channel:} \;\; R_{\text{DS(on)}} \leq 0.2 \;\; \text{, V}_{\text{GS}} \;\; = -10 \; \text{V, I}_{\text{D}} = -4 \; \text{A} \end{split}$$

- Capable of 4 V gate drive
- Low drive current
- High speed switching
- High density mounting
- Suitable for H-bridged motor driver



#### Outline



#### **Absolute Maximum Ratings** $(Ta = 25^{\circ}C)$

		Ratings		
Item	Symbol	Nch	Pch	Unit
Drain to source voltage	V <sub>DSS</sub>	60	-60	V
Gate to source voltage	V <sub>GSS</sub>	±20	±20	V
Drain current	I <sub>D</sub>	8	-8	A
Drain peak current	l <sub>D(pulse)</sub> *1	32	-32	A
Body to drain diode reverse drain current	I <sub>DR</sub>	8	-8	A
Channel dissipation	Pch (Tc = 25°C)*2	32		W
Channel dissipation	Pch*2	4		W
Channel temperature	Tch	150		°C
Storage temperature	Tstg	-55 to +1	150	°C

Notes: 1. PW  $\leq$  10 µs, duty cycle  $\leq$  1%

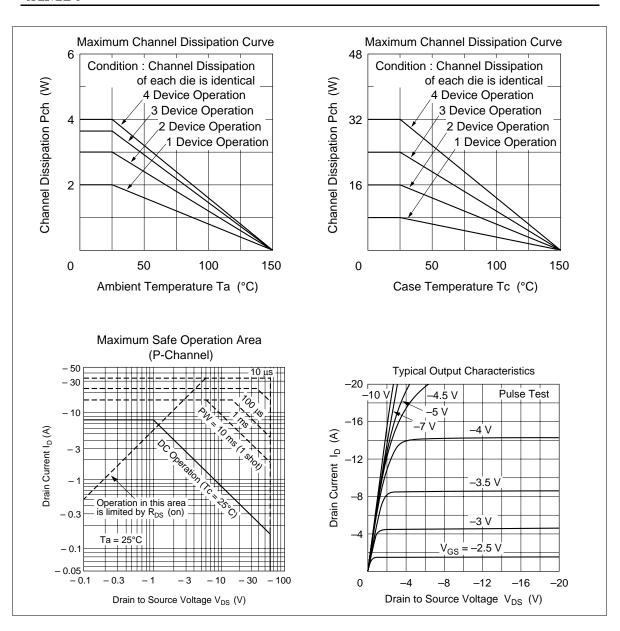
2. 4 devices operation

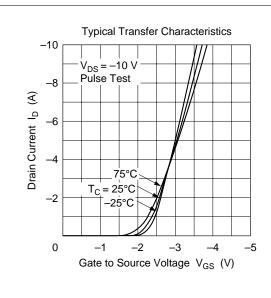
#### **Electrical Characteristics** (Ta = 25°C) (1 Unit)

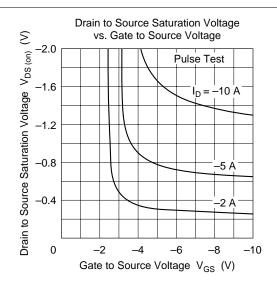
		N ch	annel		P channel				
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	-60	_	_	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	±20	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	250	_	_	-250	μΑ	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	1.0	_	2.0	-1.0	_	-2.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source	$R_{\scriptscriptstyle DS(on)}$		0.13	0.17	_	0.15	0.2	Ω	$I_D = 4 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
on state resistance		_	0.18	0.24	_	0.20	0.27	Ω	$I_D = 4 \text{ A}, V_{GS} = 4 \text{ V}^{*1}$
Forward transfer admittance	y <sub>fs</sub>	3.5	5.5	_	3.5	6.0	_	S	$I_D = 4 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	_	400	_	_	900	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	220	_	_	460	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	60	_	_	130	_	pF	_
Turn-on delay time	t <sub>d(on)</sub>	_	5	_	_	8	_	ns	$I_D = 4 A, V_{GS} = 10 V,$
Rise time	t <sub>r</sub>	_	45	_	_	50	_	ns	$R_L = 7.5 \Omega$
Turn-off delay time	t <sub>d(off)</sub>	_	150	_	_	180	_	ns	_
Fall time	t <sub>f</sub>		85	_	_	95	_	ns	_
Body to drain diode forward voltage	$V_{DF}$	_	1.2			-1.2	_	V	$I_F = 8 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	120	_	_	185	_	ns	$I_F = 8 \text{ A}, V_{GS} = 0,$ $dIF/dt = 50 \text{ A/}\mu\text{s}$

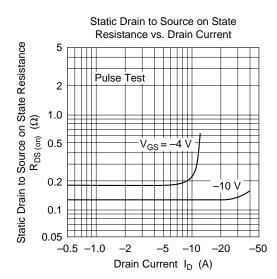
Note: 1. Pulse Test

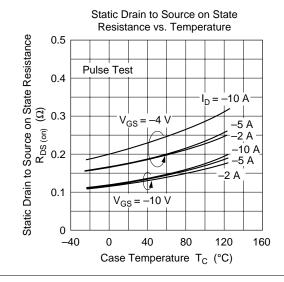
Polarity of test conditions for P channel device is reversed.

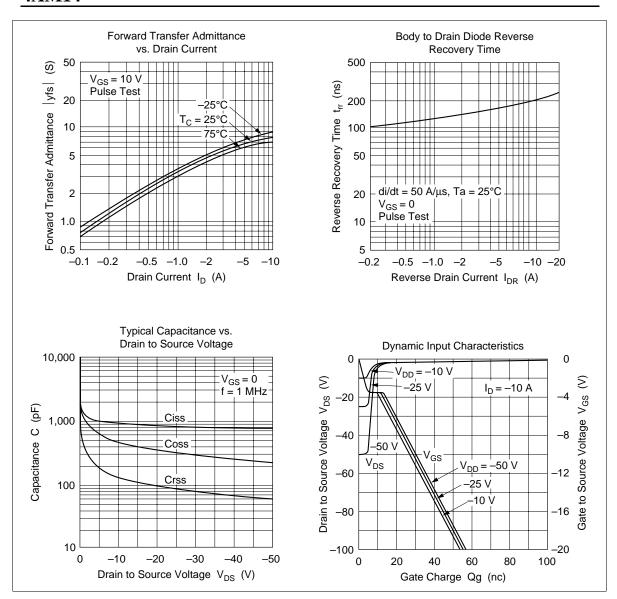


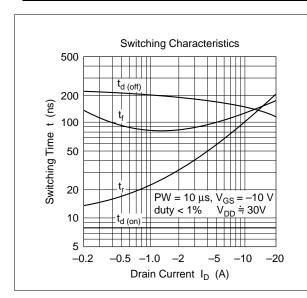


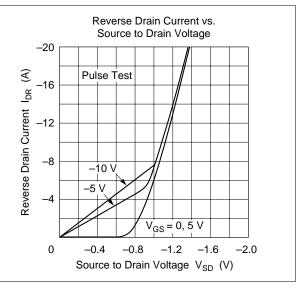


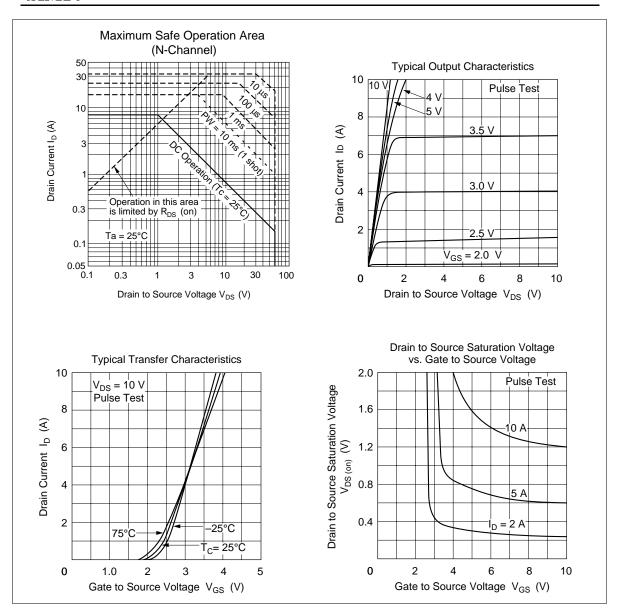


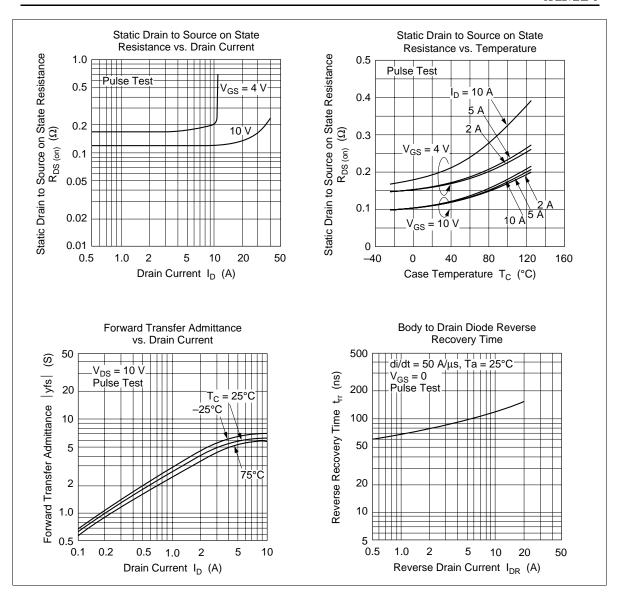


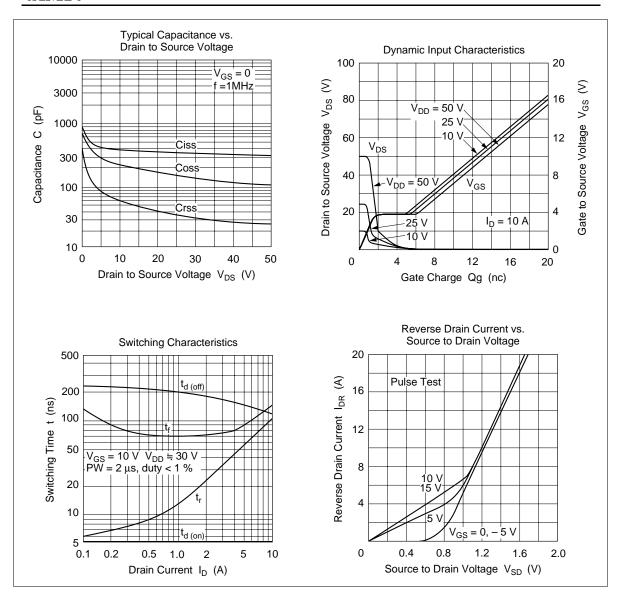




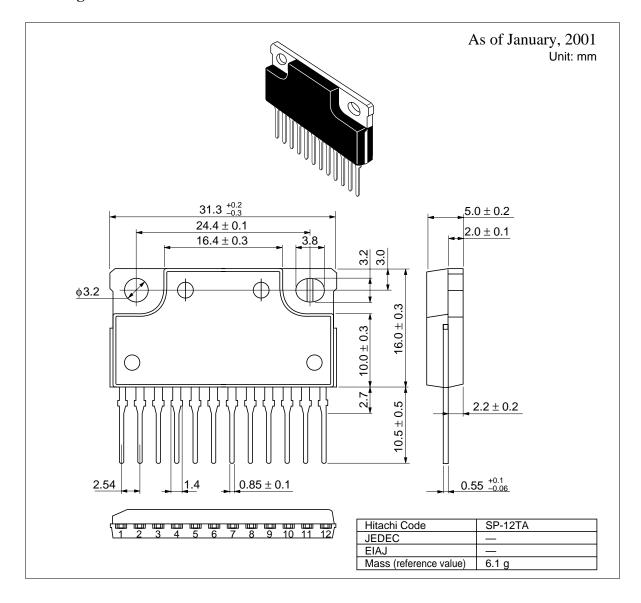








#### **Package Dimensions**



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